

SPECIFICATION

CURING COMPOSITION OF FLUORORUBBER AND MOLDED ARTICLE OF
FLUORORUBBER

5 FIELD OF THE INVENTION

The present invention relates to a curing composition of
a fluororubber, and a molded article of a fluororubber. In
particular, the present invention relates to a curable composition
of a fluororubber, which provides a molded article having
10 practically sufficient properties, for example, heat-resistance,
without secondary curing, and a molded article of a fluororubber
which is produced by molding and curing such a composition.

BACKGROUND ART

Fluororubbers are used as industrial materials in a wide
15 variety of technical fields, since they have much better
heat-resistance, oil-resistance, solvent-resistance,
chemical-resistance, etc. than general-purpose rubbers.

Fluororubbers are often used under severe conditions such
as a temperature of 200°C by making use of their particularly good
20 heat-resistance. However, for achieving heat-resistance under
such severe conditions, it is inevitable to mold the curable
composition of fluororubbers, subjecting the molded article to
primary curing and then subjecting the cured article to secondary
curing to complete crosslinking and to release gasses generated
25 in the course of crosslinking.

SUMMARY OF THE INVENTION

However, a curing composition comprising a fluororubber,
which provides a molded article having practically sufficient

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properties only by primary curing without secondary curing, has been sought, since the secondary curing requires a large amount of heat energy and additional work.

Thus, one object of the present invention is to provide such
5 a curing composition of a fluororubber.

Accordingly, the present invention provides a curing composition of a fluororubber comprising a fluororubber which is curable with an organic peroxide, a polyfunctional unsaturated compound, and an organic peroxide, wherein the total amount of
10 acetone and tert.-butanol contained in the decomposed products of said organic peroxide, which are generated at a curing temperature, is 2 moles or less per one mole of the decomposed products.

DETAILED DESCRIPTION OF THE INVENTION

15 Fluororubbers contained in the composition of the present invention may be any known fluororubbers that can be cured with organic peroxides. Preferred examples of such fluororubbers are as follows:

Vinylidene fluoride base fluororubbers:

20 VdF-HFP copolymers, VdF-HFP-TFE copolymers, VdF-PFP copolymers, VdF-PFP-TFE copolymers, VdF-PEMVE-TFE copolymers, VdF-PFMVE-HFP copolymers, VdF-CTFE copolymers, VdF-HFP-E copolymers, VdF-HFP-TFE-E copolymers

The abbreviations used in the above have the following
25 meanings:

VdF: Vinylidene fluoride

HFP: Hexafluoropropylene

TFE: Tetrafluoroethylene

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PFP: Pentafluoropropylene

PFMVE: Perfluoro(methyl vinyl ether)

CTFE: Chlorotrifluoroethylene

E: Ethylene

5 Propylene-tetrafluoroethylene fluororubbers:

Propylene (30-60 mole %)-tetrafluoroethylene (40-70 mole %) copolymers

Such copolymers may comprise 0 to 20 mole % of one or more other monomers which can be copolymerizable therewith.

10 Tetrafluoroethylene-perfluoro(alkyl vinyl ether) copolymers:

Tetrafluoroethylene (40-85 mole %)-perfluoro(alkyl vinyl ether) (15-60 mole %) copolymers

Other fluororubbers:

15 Fluorosilicone rubbers, polyfluoroalkoxyphosphazene rubbers.

There are various methods to make fluororubbers curable with organic peroxides.

For example, fluororubbers are prepared by polymerizing 20 monomers in the presence of iodine-containing compounds such as CH_2I_2 , or iodine/bromine-containing compounds such as CH_2IBr , by copolymerizing diene compounds such as $\text{CF}_2=\text{CF}-\text{CF}=\text{CF}_2$, or by heat treating prepared polymer to introduce double bonds in molecules.

25 Polyfunctional unsaturated compounds contained in the composition of the present invention may be ones that are known as curing aids. Preferred examples of polyfunctional unsaturated compounds are triallyl isocyanurate, trimethallyl isocyanurate, triallyl cyanurate, triacryl formal, triallyl trimellitate, etc.

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The amount of polyfunctional unsaturated compounds is from 0.1 to 10 wt. parts, preferably from 1 to 5 wt. parts, per 100 wt. parts of the fluororubbers.

Organic peroxides used according to the present invention are such compounds that generate decomposed products containing acetone and tert.-butanol in a total amount of 2 moles or less per one mole of the decomposed products, when they are decomposed under a curing temperature condition.

Table 1 summarizes the compositions of low-boiling decomposed products of several known organic peroxides under curing temperature conditions.

Table 1

Organic peroxide	Low-boiling decomposed products (mole/mole)			
	Methane	Ethane	Acetone	tert.-butanol
1	0.56	0.37	2.14	1.30
2	1.15	0	0	0
3	0.62	0	0.32	0.7
4	0.53	0	0.56	1.14

Notes 1: 2,5-Dimethyl-2,5-bis(tert.-butylperoxy)hexane (Perhexa 25B)

- 2: Dicumyl peroxide (Percumyl D)
 3: tert.-Butylcumyl peroxide (Perbutyl C)
 4: di-tert.-Butyl peroxide (Perbutyl D)

Among the organic peroxides which generate decomposed products containing 2 mole/mole or less of acetone and tert.-butanol in total, dicumyl peroxide is preferable, since it generates neither acetone nor tert.-butanol.

The amount of organic peroxides is from 0.3 to 1.2 wt. parts, preferably from 0.4 to 1.0 wt. parts, per 100 wt. parts of fluororubbers. When the amount of organic peroxides exceeds 1.2

wt. parts, the weight change in use increases, which may cause some practical problems.

The curing composition of fluororubbers according to the present invention may optionally contain conventional additives which are compounded in fluororubbers, for example, fillers, processing aids, plasticizers, colorants, etc.

The curing composition of fluororubbers according to the present invention can provide cured molded articles, which have practically sufficient properties and in which the contribution of secondary curing to a compression set (which will be defined below) is 30 % or less, only by primary curing which is applied to the conventional curing compositions of fluororubbers.

Curing conditions may be the same as those used to cure the conventional curing compositions of fluororubbers. For example, the compositions are cured for 0.1 to 1 hours at a curing temperature in a range between 150 and 190°C, under a curing pressure in a range between 1 and 10 Pa.

EXAMPLES

Comparative Example 1

Medium thermal carbon (MT-C) (20 wt. parts), triallyl isocyanurate (TAIC-M60, 60 % diluted product of triallyl isocyanurate, manufactured by NIPPON KASEI KABUSHIKI KAISHA) (6.7 wt. parts) and Perhexa 25B (manufactured by NOF Corporation) (0.5 wt. part) were compounded in DAIEL G-912 (an iodine-containing fluororubber manufactured by DAIKIN INDUSTRIES, LTD.) (100 wt. parts), and well kneaded on open rolls to obtain a testing compound.

The obtained compound was molded, and subjected to primary

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curing at 160°C for 10 minutes, and secondary curing at 180°C for 4 hours to obtain a sheet (120 mm x 150 mm x 2 mm) for the measurement of physical properties, and a P-24 O-ring for the measurement of a compression set.

- 5 With a molded product which had been primarily cured and one which had been primarily and secondarily cured, the following measurements were carried out.

M_{100} (100 % modulus), T_s (tensile strength at break) and E_b (elongation at break) of a sheet were measured according to JIS K6301, and H_s (hardness) of a sheet was measured according to JIS K6253, Type A.

ΔW was a weight change rate expressed by the formula:

$$[(\text{weight of secondarily cured product} - \text{weight of primarily cured product}) / (\text{weight of primarily cured product})] \times 100 \%$$

- 15 CS (compression set) was measured using a P-24 O-ring, which is defined by JIS B2401, under the conditions of 200°C, 70 hours and 25 % compression, according to JIS K6301.

The contribution of secondary curing to a compression set was evaluated by the formula:

- 20
$$[(CS_1 - CS_2) / CS_2] \times 100 \%$$

in which CS_1 is the compression set of a primarily cured product, and CS_2 is the compression set of a secondarily cured product.

Comparative Examples 2 and 3

- 25 A composition was prepared, a sheet and an O-ring were molded and then their properties were measured by the same methods as in Comparative Example 1 except that the amount of Perhexa 25B was changed to 1.0 wt. part or 1.5 wt. parts.

Comparative Examples 4 and 5

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A composition was prepared, a sheet and an O-ring were molded and then their properties were measured by the same methods as in Comparative Example 1 except that 0.25 wt. part or 1.5 wt. parts of Percumyl D (manufactured by NOF Corporation) was used in place of Perhexa 25B.

Comparative Example 6

A composition was prepared, a sheet and an O-ring were molded and then their properties were measured by the same methods as in Comparative Example 1 except that DAIEL G-902 (an iodine-containing fluororubber manufactured by DAIKIN INDUSTRIES, LTD.) was used as a fluororubber.

Comparative Example 7

A composition was prepared, a sheet and an O-ring were molded and then their properties were measured by the same methods as in Comparative Example 1 except that DAIEL G-902 (an iodine-containing fluororubber manufactured by DAIKIN INDUSTRIES, LTD.) was used as a fluororubber, and the amount of Perhexa 25B was changed to 1.5 wt. parts.

Examples 1 and 2

A composition was prepared, a sheet and an O-ring were molded and then their properties were measured by the same methods as in Comparative Example 1 except that 0.5 wt. part or 1.0 wt. part of Percumyl D was used in place of Perhexa 25B.

Example 3

A composition was prepared, a sheet and an O-ring were molded and then their properties were measured by the same methods as in Comparative Example 1 except that 1.0 wt. part of Perbutyl C was used in place of Perhexa 25B.

Example 4

A composition was prepared, a sheet and an O-ring were molded and then their properties were measured by the same methods as in Comparative Example 1 except that 1.0 wt. part of Perbutyl D
5 was used in place of Perhexa 25B.

Example 5

A composition was prepared, a sheet and an O-ring were molded and then their properties were measured by the same methods as in Comparative Example 1 except that DAIEL G-902 (an iodine-
10 containing fluororubber manufactured by DAIKIN INDUSTRIES, LTD.) was used as a fluororubber, and 0.5 wt. part of Percumyl D was used in place of Perhexa 25B.

The results are shown in Table 2.

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Table 2

	Comparative Example No.							Example No.				
	1	2	3	4	5	6	7	1	2	3	4	5
Composition	100	100	100	100	100	---	---	100	100	100	100	---
-DAIEL G-912	---	---	---	---	---	100	100	---	---	---	---	100
-DAIEL G-902	20	20	20	20	20	20	20	20	20	20	20	20
-MT-C	6.7	6.7	6.7	6.7	6.7	6.7	6.7	6.7	6.7	6.7	6.7	6.7
-TAIC M60	0.5	1.0	1.5	---	---	0.5	1.5	---	---	---	---	---
-Perhexa 25B	---	---	---	0.25	1.5	---	---	0.5	1.0	---	---	0.5
-Percumyl D	---	---	---	---	---	---	---	---	---	1.0	---	---
-Perbutyl C	---	---	---	---	---	---	---	---	---	---	---	---
-Perbutyl D	---	---	---	---	---	---	---	---	---	---	1.0	---
Mechanical properties												
aft. primary curing												
(160°C x 10 min.)												
-M ₁₀₀	112	119	114	62	115	37	40	119	100	128	131	39
-T _B	205	216	186	166	195	180	206	211	195	225	227	184
-E _B	175	170	170	240	170	350	310	175	170	175	165	320
-Hs	74	75	73	73	73	72	71	75	74	74	75	72
-CS (200°C x 70 hrs)	29.5	24.9	25.0	37.0	24.0	27	30.0	21.8	21.2	23.9	23.3	23
Mechanical properties												
aft. secondary curing												
(180° x 4 hrs.)												
-M ₁₀₀	152	147	154	89	151	46	51	148	135	164	153	49
-T _B	273	252	284	228	248	230	254	253	264	275	276	221
-E _B	175	165	160	210	160	300	280	165	160	165	165	300
-Hs	77	77	77	74	77	72	74	77	76	77	77	72
-CS (200°C x 70 hrs)	20.4	17.3	17.1	18.9	17.3	23.0	28.0	19.0	16.9	19.1	18.0	21
-ΔW (%)	0.44	0.85	1.20	0.42	1.13			0.51	0.42	0.76	0.37	
[(CS ₁ -CS ₂)/CS ₂]]x100 (%)	44.6	43.9	46.2	95.8	38.7	17.4	7.1	14.7	25.4	25.1	29.4	9.5

As can be understood from the results of Examples 1-5, the compositions of the present inventions provide O-rings having a small compression set (200°C x 70 hours) only by primary curing.

As can be seen from the results of Comparative Example 4,
5 the use of dicumyl peroxide in an amount of 0.25 wt. part deteriorates a compression set, since the curing does not sufficiently proceed. The results of Comparative Example 5 indicates that the use of dicumyl peroxide in an amount of 1.5 wt. parts significantly increases the weight change ΔW (%).

10 Molded articles, which are produced by curing the compositions of the present invention, have less contribution of secondary curing to a compression set, and achieve a smaller compression set than those produced from conventional compositions after the primary curing, when the same fluororubbers
15 are used. Thus, it is understood that molded articles produced from the compositions of the present invention have good practical usefulness without being secondarily cured.

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